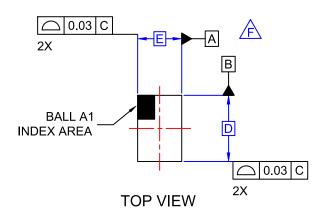
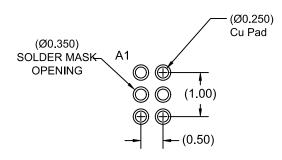


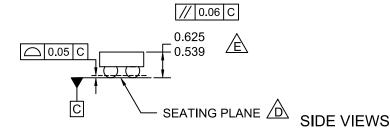
WLCSP6 1.5x1.0x0.582 CASE 567RL ISSUE O

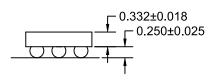
DATE 30 NOV 2016

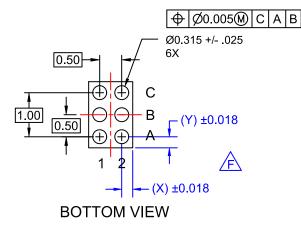




RECOMMENDED LAND PATTERN (NSMD PAD TYPE)







NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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|------------------|----------------------|---|-------------|
| DESCRIPTION: | WLCSP6 1.5x1.0x0.582 | | PAGE 1 OF 1 |

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